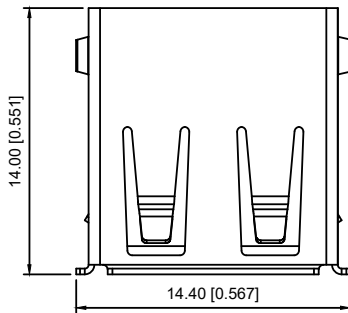


PCB LAYOUT
XKB Connectivity

NOTES:

1.材料规格 MATERIAL SPECIFCATION:

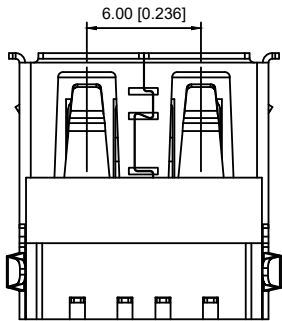
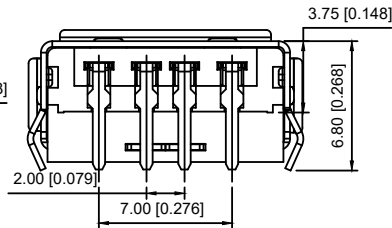
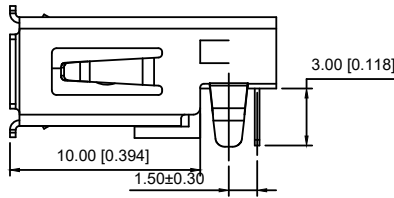
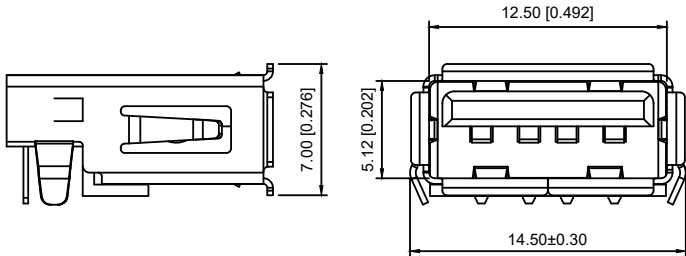
- 1) 胶壳 HOUSING MATERIAL:BLACK PBT ROHS;
2) 外壳 SHELL MATERIAL:SPCC T=0.30
电镀 PLATING:NICKE;
3) 端子 TERMINAL: C5191 T=0.25
电镀 PLATING:SEMI GOLD TIN G/F;

2.电气特性 ELECTRICAL CHARACTERISTIC:

- 1) 绝缘电阻 INSULATION RESISTANCE: 1000MΩ MIN;
2) 接触电阻 CONTACT RESISTANCE: 30mΩ MAX;
3) 耐压 WITHSTANDING VOLTAGE: 500V AC;

3.机器特性 MECHANICAL CHARACTERISTICS:

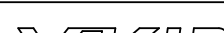
- 1) 插入力 INSERTION FORCE:3.57Kgf Max;
2) 拔出力 EXTRACTION FORCE:1.02Kgf Min;



XKB Connectivity

U221-041N-1BCV70-S1

- 1:Au 1U"
6:Au 30U"
W:WHITE
B:BLACK
1:PBT
2:PA6T
3:PA9T
4:LCP
1:SPCC 5:BRASS
S:Scrolls F:Flat

							DSND		SCALE: N/A	MODEL TYPE: USB 2.0			
						ANGLAR	±5°		DWN		VIEW: 	PART NO.: U221-041N-1BCV70-S1	
Δx						L ≤ 4	±0.2		CHKD		UNIT: mm/in	DWG NO.: U221-041N-1BCV70-S1	
Δx						4<L ≤ 16	±0.3		APPD		SIZE: A4		
Δx						16<L ≤ 63	±0.4						
MARK	DESCRIPTION			DATE	REVISED	APPROVED	L > 63	±0.5					
REVISIONS							UNSPECIFIED TOLERANCES		XKB INDUSTRIAL PRECISION CO.,LIMITED				
www.helloxkb.com www.helloxkb.cn www.xk-dg.cn									WEIGHT SHEET REVISION				
									1/1 A0				